AMENDMENT TRANSMITTAL LETTER (Large Entity) Applicant(s): William Palmteer						Docket No. Whitaker No. 17541		
Serial No. Fi 09/590,406		g Date 8/00		Examiner Quynh-Hnu H. Vu			Group Art Unit 2841	
Invention SOLDER-COATED ARTICLE USEFULE FOR SUBSTRATE ATTACHMENT FEB 1 0 2003								
TO THE ASSISTANT COMMISSIONER FOR PATENTS: Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.								
	CLAIMS AS AMENDED						288	
	CLAIMS REMAINING	HIGHEST #	NUMB	ER EXTRA		RATE	ADDITIONAL	
	AFTER AMENDMENT	PREV. PAID FOR		PRESENT	ļ		FEE CO.O.	
TOTAL CLAIMS	26 -		=		 	\$18.0		
INDEP. CLAIMS	6 -		=	0	х	\$84.0		
Multiple Dependent Claims (check if applicable) \$0.00								
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT \$0.00								
 No additional fee is required for amendment. □ Please charge Deposit Account No. in the amount of A duplicate copy of this sheet is enclosed. □ A check in the amount of to cover the filing fee is enclosed. ☑ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-5425 A duplicate copy of this sheet is enclosed. ☑ Any additional filing fees required under 37 C.F.R. 1.16. ☑ Any patent application processing fees under 37 CFR 1.17. ☐ Dated: 2 4 03 ☐ Certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to certify that this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this document and fee is being deposited to charge payment of the following fees associated with this communication of the following fees associated with the following fees associated with this communication of the fo								
on 2/#03 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Philadelphia, PA 19107 (215) 923-4466 Assistant Commissioner for Patents, Washington, D.C. 20231.								

CC:

Katrina Lynn

Typed or Printed Name of Person Mailing Correspondence

oplication No. 09/590,406

Whitaker Docket No. 17547, PER 3003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: William Palmteer

Application No.: 09/590,406

Examiner: Quynh-Nhu H. Vu

Filing Date: June 8, 2000

Group Art: 2841

Title: SOLDER-COATED ARTICLE USEFUL FOR SUBSTRATE ATTACHMENT

CERTIFICATE OF MAILING

I hereby certify that this correspondence, along with any papers indicated as being enclosed, are being deposited as First Class Mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on February 4, 2003,

Commissioner for Patents Washington, DC 20231

AMENDMENT

Sir:

Responsive to the second Office Action dated November 6, 2002, Applicant amends the application as noted below and respectfully requests favorable reconsideration of this application.

In the Claims

Please amend the claims as noted below.

1. (Twice Amended) A solder-coated article comprising:

a substantially non-deformable dielectric core having a largest dimension ranging from 1 to 1000 microns;